Technical data sheet



wedi Noustep Plus | impact sound deadening board

- Thin-layer impact sound insulation under tiles, laminate and ready-to-lay parquet
- On all load-bearing floors indoors
- Low structural height



General product description

The wedi Nonstep Plus impact sound deadening board consists of a 6 mm wedi building board bonded in the factory to a 6 mm rubber mat, creating an overlap. The impact sound deadening board is used for decoupling under ceramic floor coverings, laminate or ready-to-lay parquet.

Applications

- For decoupling ceramic and natural stone floor coverings from the substructure
- For deadening impact sound when laying ceramic and natural stone floor coverings with a relatively low design height
- On all load-bearing surfaces such as concrete, wooden floorboards (not stairs)
- Underlay for floating floor coverings such as ready-to-lay parquet or laminate
- Not for use under electric thin-bed heating elements
- For residential type use. Not approved for wheeled loads with high concentrated loads.

Product properties

- Low structural height
- Low mass per unit area
- Simple to lay, an economic way of reducing impact sound under ceramic and natural stone floor coverings
- Quick installation
- Stress-reducing board, decouples the covering from the surface
- Impact sound improved by 16 dB

Surface requirements

The surfaces must be even, clean, load-bearing, dry and free of vibrations. Any unevenness must be levelled out before laying. Make sure that Nonstep Plus covers the entire area.

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Old floor coverings

When replacing old floor coverings (e.g. linoleum, carpet, PVC) with ceramic and natural stone floor coverings, all the old coverings must be removed and any resulting unevenness must be levelled out.

Old ceramic, artificial stone or natural stone coverings

Hollow slabs must be removed and the unevenness must be levelled out.

Concrete floors, screeds

Screeds must be even in accordance with DIN 18202 "Dimensional tolerances in building construction". Any unevenness must be levelled out with a suitable levelling compound.

Wooden floorboards

Existing wooden beam ceilings must be checked for their loadbearing capacity. The wooden structure must not sag or give (deflection max. I/300) and must be as rigid as possible and secured against height offsets. Loose planks or floorboards must be screwed back into place if necessary. Uneven floorboards must be levelled out (remove the board seams, prime the floorboards and level out with a levelling compound).

The following minimum specifications for wooden substructures must be met:

Solid wooden boards: \geq 16 mm, p \geq 600 kg/m³ Plywood boards: \geq 16 mm, p \geq 520 kg/m³

Planks/floorboards: ≥ 21 mm

Processing

Lay an edge insulating strip all round. Lay wedi Nonstep Plus loose on the even surface. Avoid cross joints. Apply a wide reinforcement tape over the entire area. First apply a contact layer to the surface with a flexible thin-bed mortar, then lay in the tape with a 5 cm overlap and finally cover it with mortar (recommended: wedi 320 tile adhesive universal and wedi Tools reinforcement tape).

N.B.

- Do not use small tiles less than 10 x 10 cm in size.
- Minimum tile thickness ≥ 8 mm
- Ceramic tiles and slabs should have a minimum breaking force of 1500 N
- Grouting complying with ATV DIN 18352 "Working with tiles and slabs" and ATV DIN 18332 "Working with natural stone" (grouting width \geq 3 mm)
- Arrangement of expansion joints complying with DIN 18157 parts 1 – 3 "Application of ceramic tiling using the thin-bed method" (side length of the fields ≤ 8 m, compact fields with maximum field size of 40 m², joint width 5 – 10 mm)
- Expansion joints in the surface and structural joints must be matched when fitting wedi Nonstep Plus
- If at all possible, lay ceramic and natural stone coverings without any cavities
- If you use Nonstep Plus in wet or humid areas of load classes A0 and A, wedi sealing set has to be applied to all joints

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Technical properties of impact sound deadening board

Bottom	polyurethane-bonded recycled rubber material with styrofoam flakes
Тор	6 mm wedi building board bonded with a rubber mat at the factory,
	creating an overlap
Thickness	12 mm
Format	1200 x 600 mm (with overlap)
Temperature resistance	-40°C to 75°C
Impact sound deadening	Δ L _{W,R} = 16 dB in accordance with DIN 52210 (tested on concrete ceiling, under tiles)

Packing

Boards on pallets

Storage

In principle wedi Nonstep Plus boards should be stored flat. They must be protected against direct sunlight and moisture.

Safety notice

none